

# 2MBI300UE-120



## IGBT Module U-Series

1200V / 300A 2 in one-package

### ■ Features

- High speed switching
- Voltage drive
- Low inductance module structure
- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Conditions		Rating	Unit
Collector-Emitter voltage	$V_{CES}$			1200	V
Gate-Emitter voltage	$V_{GES}$			$\pm 20$	V
Collector current	$I_c$	Continuous	$T_c=25^\circ\text{C}$	450	A
			$T_c=80^\circ\text{C}$	300	
	$I_{cp}$	1ms	$T_c=25^\circ\text{C}$	900	
			$T_c=80^\circ\text{C}$	600	
	- $I_c$			300	
	- $I_c$ pulse			600	
Collector Power Dissipation	$P_c$	1 device		1660	W
Junction temperature	$T_j$			+150	$^\circ\text{C}$
Storage temperature	$T_{stg}$			-40 to +125	
Isolation voltage   between terminal and copper base *1	$V_{iso}$	AC:1min.		2500	VAC
Screw Torque	Mounting *2			3.5	N·m
		Terminals *2		4.5	

\*1 : All terminals should be connected together when isolation test will be done.

\*2 : Recommendable value : Mounting 2.5 to 3.5 N·m(M5 or M6), Terminals 3.5 to 4.5N·m(M6)

#### ● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

Item	Symbols	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Zero gate voltage collector current	$I_{CES}$	$V_{GE}=0\text{V}$ , $V_{CE}=1200\text{V}$	—	—	3.0	mA	
Gate-Emitter leakage current	$I_{GES}$	$V_{CE}=0\text{V}$ , $V_{GE}=\pm 20\text{V}$	—	—	600	nA	
Gate-Emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE}=20\text{V}$ , $I_c=300\text{mA}$	4.5	6.5	8.5	V	
Collector-Emitter saturation voltage	$V_{CE(\text{sat})}$ (terminal)	$V_{GE}=15\text{V}$ , $I_c=300\text{A}$	—	1.95	2.30	V	
		$T_j=25^\circ\text{C}$	—	2.20	—		
	$V_{CE(\text{sat})}$ (chip)	$T_j=125^\circ\text{C}$	—	1.75	2.10		
		$T_j=25^\circ\text{C}$	—	2.00	—		
Input capacitance	$C_{ies}$	$V_{CE}=10\text{V}$ , $V_{GE}=0\text{V}$ , $f=1\text{MHz}$	—	34	—	nF	
Turn-on time	$t_{on}$	$V_{CC}=600\text{V}$ $I_c=300\text{A}$ $V_{GE}=\pm 15\text{V}$	—	0.36	1.20	$\mu\text{s}$	
	$t_r$		—	0.21	0.60		
	$t_{r(j)}$		—	0.03	—		
	$t_{off}$		—	0.37	1.00		
Turn-off time	$t_f$		—	0.07	0.30		
Forward on voltage	$V_F$ (terminal)	$V_{GE}=0\text{V}$ $I_F=300\text{A}$	$T_j=25^\circ\text{C}$	—	1.75	V	
			$T_j=125^\circ\text{C}$	—	1.85		
	$V_F$ (chip)		$T_j=25^\circ\text{C}$	—	1.60		
			$T_j=125^\circ\text{C}$	—	1.70		
Reverse recovery time	$t_{rr}$	$I_F=300\text{A}$	—	—	0.35	$\mu\text{s}$	
Lead resistance, terminal-chip*3	$R_{\text{lead}}$		—	0.45	—	$\text{m}\Omega$	

\*3: Biggest internal terminal resistance among arm.

### ● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th(j-c)}$	IGBT	—	—	0.075	$^\circ\text{C}/\text{W}$
	$R_{th(j-c)}$	FWD	—	—	0.12	$^\circ\text{C}/\text{W}$
Contact Thermal resistance	$R_{th(c-f)}^*$ <sup>4</sup>	With thermal compound		0.0167	—	$^\circ\text{C}/\text{W}$

\*4 : This is the value which is defined mounting on the additional cooling fin with thermal compound.

### ■ Equivalent Circuit Schematic

